

GF1A - GF1M

Features

- Low forward voltage drop.
- · High current capability.
- Easy pick and place.
- High surge current capability.



SMA/DO-214AC COLOR BAND DENOTES CATHODE

General Purpose Rectifiers (Glass Passivated)

Absolute Maximum Ratings* T_A = 25 ℃ unless otherwise noted

Symbol	Parameter		Value						
		1A	1B	1D	1G	1J	1K	1M	
V_{RRM}	Maximum Repetitive Reverse Voltage		100	200	400	600	800	1000	V
I _{F(AV)}	Average Rectified Forward Current, @ T₁ = 125 °C 1.0				Α				
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave			Α					
T _{stg}	Storage Temperature Range -65 to +175				°C				
TJ	Operating Junction Temperature -65 to +175				°C				

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units	
P_D	Power Dissipation	1.8	W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	80	°C/W	
$R_{\theta JL}$	Thermal Resistance, Junction to Lead*	26	°C/W	

^{*}Device mounted on PCB with 0.2 x 0.2" (5.0 x 5.0 mm) copper pad areas.

Electrical Characteristics $T_A = 25 \, ^{\circ}\!C$ unless otherwise noted

Symbol	Parameter		Device				Units			
			1A	1B	1D	1G	1J	1K	1M	
V_{F}	Forward Voltage @ 1.0 A				1.0			1	.2	V
t _{rr}	Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		2.0						μs	
I _R		: 25°C : 125°C				5.0 50				μ Α μ Α
Ст	Total Capacitance $V_B = 4.0 \text{ V}, f = 1.0 \text{ MHz}$			15				pF		

General Purpose Rectifiers (Glass Passivated)

(continued)

Typical Characteristics

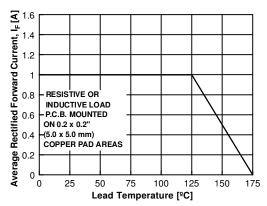


Figure 1. Forward Current Derating Curve

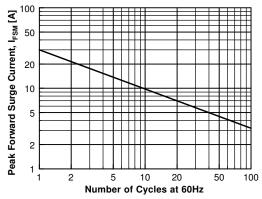


Figure 2. Non-Repetitive Surge Current

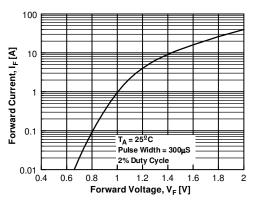


Figure 3. Forward Voltage Characteristics

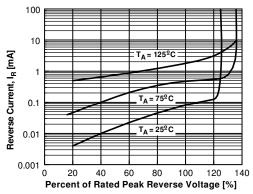


Figure 4. Reverse Current vs Reverse Voltage

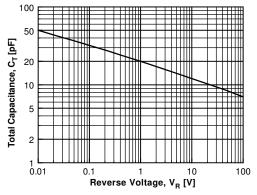


Figure 5. Total Capacitance

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